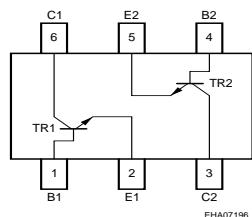


**NPN Silicon RF Transistor\***

- For low noise, high-gain broadband amplifiers at collector currents from 0.5 mA to 12 mA
- $f_T = 8$  GHz,  $F = 0.9$  dB at 900 MHz
- Two (galvanic) internal isolated Transistors in one package
- For orientation in reel see package information below
- Pb-free (RoHS compliant) package<sup>1)</sup>
- Qualified according AEC Q101

\* Short term description



**ESD (Electrostatic discharge) sensitive device, observe handling precaution!**

Type	Marking	Pin Configuration						Package
BFS481	RFs	1=B	2=E	3=C	4=B	5=E	6=C	SOT363

<sup>1</sup>Pb-containing package may be available upon special request

**Maximum Ratings**

Parameter	Symbol	Value	Unit
Collector-emitter voltage	$V_{CEO}$	12	V
Collector-emitter voltage	$V_{CES}$	20	
Collector-base voltage	$V_{CBO}$	20	
Emitter-base voltage	$V_{EBO}$	2	
Collector current	$I_C$	20	mA
Base current	$I_B$	2	
Total power dissipation <sup>1)</sup> $T_S \leq 83^\circ\text{C}$	$P_{tot}$	175	mW
Junction temperature	$T_j$	150	°C
Ambient temperature	$T_A$	-65 ... 150	
Storage temperature	$T_{stg}$	-65 ... 150	

**Thermal Resistance**

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>2)</sup>	$R_{thJS}$	$\leq 380$	K/W

**Electrical Characteristics at  $T_A = 25^\circ\text{C}$ , unless otherwise specified**

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>DC Characteristics</b>					
Collector-emitter breakdown voltage $I_C = 1 \text{ mA}, I_B = 0$	$V_{(BR)CEO}$	12	-	-	V
Collector-emitter cutoff current $V_{CE} = 20 \text{ V}, V_{BE} = 0$	$I_{CES}$	-	-	100	μA
Collector-base cutoff current $V_{CB} = 10 \text{ V}, I_E = 0$	$I_{CBO}$	-	-	100	nA
Emitter-base cutoff current $V_{EB} = 1 \text{ V}, I_C = 0$	$I_{EBO}$	-	-	1	μA
DC current gain- $I_C = 5 \text{ mA}, V_{CE} = 8 \text{ V, pulse measured}$	$h_{FE}$	70	100	140	-

<sup>1)</sup> $T_S$  is measured on the collector lead at the soldering point to the pcb

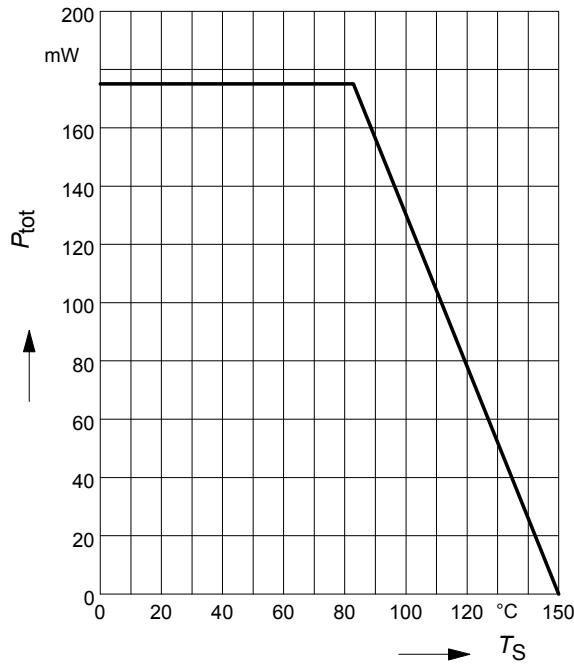
<sup>2)</sup>For calculation of  $R_{thJA}$  please refer to Application Note Thermal Resistance

**Electrical Characteristics at  $T_A = 25^\circ\text{C}$ , unless otherwise specified**

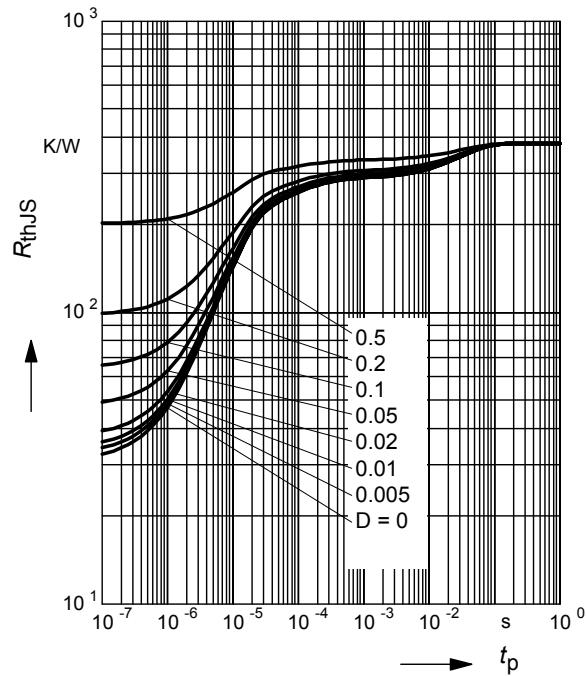
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>AC Characteristics</b> (verified by random sampling)					
Transition frequency $I_C = 10 \text{ mA}, V_{CE} = 8 \text{ V}, f = 500 \text{ MHz}$	$f_T$	6	8	-	GHz
Collector-base capacitance $V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$ , emitter grounded	$C_{cb}$	-	0.23	0.4	pF
Collector emitter capacitance $V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$ , base grounded	$C_{ce}$	-	0.13	-	
Emitter-base capacitance $V_{EB} = 0.5 \text{ V}, f = 1 \text{ MHz}, V_{CB} = 0$ , collector grounded	$C_{eb}$	-	0.4	-	
Noise figure $I_C = 2 \text{ mA}, V_{CE} = 8 \text{ V}, Z_S = Z_{\text{Sopt}}$ , $f = 900 \text{ MHz}$ $I_C = 2 \text{ mA}, V_{CE} = 8 \text{ V}, Z_S = Z_{\text{Sopt}}$ , $f = 1.8 \text{ GHz}$	$F$	-	0.9	-	dB
Power gain, maximum stable <sup>1)</sup> $I_C = 5 \text{ mA}, V_{CE} = 8 \text{ V}, Z_S = Z_{\text{Sopt}}, Z_L = Z_{\text{Lopt}}$ , $f = 900 \text{ MHz}$	$G_{ms}$	-	20	-	dB
Power gain, maximum available <sup>2)</sup> $I_C = 5 \text{ mA}, V_{CE} = 8 \text{ V}, Z_S = Z_{\text{Sopt}}, Z_L = Z_{\text{Lopt}}$ , $f = 1.8 \text{ GHz}$	$G_{ma}$	-	15	-	dB
Transducer gain $I_C = 5 \text{ mA}, V_{CE} = 8 \text{ V}, Z_S = Z_L = 50 \Omega$ , $f = 900 \text{ MHz}$ $I_C = 5 \text{ mA}, V_{CE} = 8 \text{ V}, Z_S = Z_L = 50 \Omega$ , $f = 1.8 \text{ MHz}$	$ S_{21e} ^2$	-	16	-	dB
<sup>1</sup> $G_{ms} =  S_{21} / S_{12} $					
<sup>2</sup> $G_{ma} =  S_{21e} / S_{12e}  (k - (k^2 - 1)^{1/2})$					

<sup>1</sup> $G_{ms} = |S_{21} / S_{12}|$ 
<sup>2</sup> $G_{ma} = |S_{21e} / S_{12e}| (k - (k^2 - 1)^{1/2})$

**Total power dissipation  $P_{\text{tot}} = f(T_S)$**

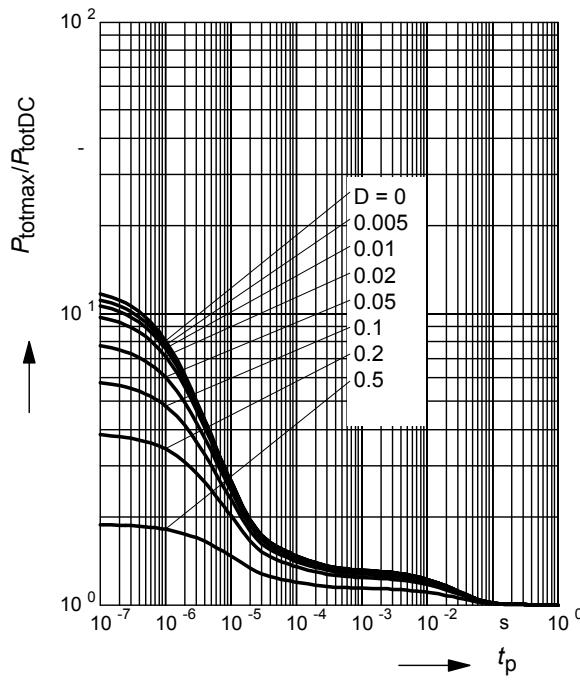


**Permissible Pulse Load  $R_{\text{thJS}} = f(t_p)$**

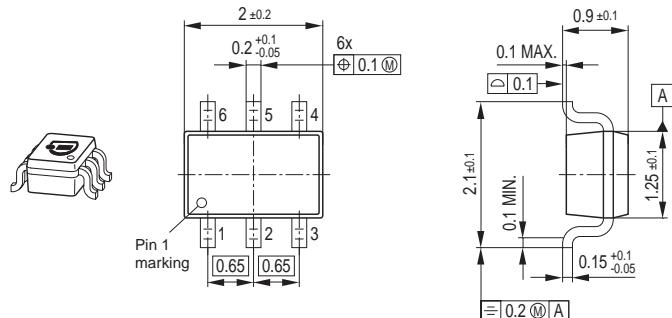


### Permissible Pulse Load

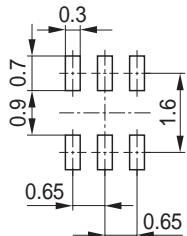
$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$



## Package Outline

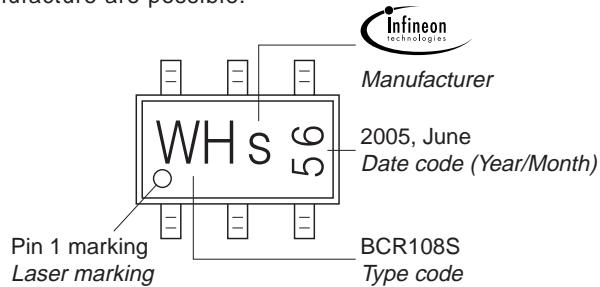


## Foot Print



## Marking Layout (Example)

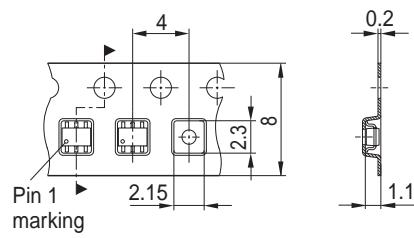
Small variations in positioning of Date code, Type code and Manufacture are possible.



## Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel  
Reel ø330 mm = 10.000 Pieces/Reel

For symmetric types no defined Pin 1 orientation in reel.



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2007-04-26